### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicants** 

: Tian-Qiang Sun et al.

Filed

July 30, 2001

For

ISOLATION OF DROSOPHILA AND HUMAN

POLYNUCLEOTIDES ENCODING PAR-1 KINASE,

POLYPEPTIDES ENCODED BY THE POLYNUCLEOTIDES AND

METHODS UTILIZING THE POLYNUCLEOTIDES AND

POLYPEPTIDES

Docket No.

PP-016093.002/200130.525

Date

July 30, 2001

Box Patent Application Commissioner for Patents Washington, D.C. 20231

#### **DECLARATION**

Sir:

I, Monica Steinborn, in accordance with 37 C.F.R. § 1.821(f) do hereby declare that, to the best of my knowledge, the content of the paper entitled "Sequence Listing" and the computer readable copy contained within the floppy disk are the same.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Dated this 30<sup>th</sup> day of July, 2001.

Monica Steinborn

Biotechnology Paralegal

#### DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

# ISOLATION OF DROSOPHILA AND HUMAN POLYNUCLEOTIDES ENCODING PAR-1 KINASE, POLYPEPTIDES ENCODED BY THE POLYNUCLEOTIDES AND METHODS UTILIZING THE POLYNUCLEOTIDES AND POLYPEPTIDES

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the specification	of which (check o	ne) is attached he	reto <u>x</u> was fi	led on
uury 30, 2001 as	0.5. Application 5	eriai No and	was amended	
	(if ap	plicable).		
			•	
hereby state th	at I have reviewed	and understand the cont	ents of the above	<u>;</u> –
dentified specif	ication, including	the claims, as amended	referred to above	· .
達	_			
🗓 acknowledge the	duty to disclose	information which is mat	erial to the exam	nination of
this application	in accordance with	Title 37, Code of Feder	al Regulations, S	Section
11.56(a).		·	, , .	
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	reian priority ben	efits under Title 35, Un	ited States Code.	\$119 of
		nt or inventor's certifi		
		pplication for patent or		
		the application on whic		
maving a liling a	acc before that of	the application on white	n priority is the	ilmed.
Prior Foreign App	lication(s)		Priority Claim	ned
Number	Country	Day/Month/Year Filed	<u>Yes</u> <u>No</u>	
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I hereby claim the benefit under Title 35, United States Code, \$120 and/or 119(e) of any United States application(s) and/or provisional application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, \$112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, \$1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.

Filing Date

## Status Patented, Pending, Abandoned

60/221,860

July 28, 2000

Pending

I hereby declare that all statements herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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